



DMOS

400mA Low-Dropout Regulator

FEATURES

- **CAP-FREE DMOS TOPOLOGY:**
Ultra Low Dropout Voltage:
250mV typ at 400mA
Output Capacitor *not* Required for Stability
- **UP TO 500mA PEAK, TYPICAL**
- **FAST TRANSIENT RESPONSE**
- **VERY LOW NOISE: 28µVrms**
- **HIGH ACCURACY: ±1.5% max**
- **HIGH EFFICIENCY:**
 $I_{GND} = 850\mu A$ at $I_{OUT} = 400mA$
Not Enabled: $I_{GND} = 0.01\mu A$
- **2.5V, 2.85V, 3.0V, 3.3V, AND 5.0V OUTPUT VERSIONS**
- **OTHER OUTPUT VOLTAGES AVAILABLE UPON REQUEST**
- **FOLDBACK CURRENT LIMIT**
- **THERMAL PROTECTION**
- **SMALL SURFACE-MOUNT PACKAGES:**
SOT23-5 and MSOP-8

APPLICATIONS

- **PORTABLE COMMUNICATION DEVICES**
- **BATTERY-POWERED EQUIPMENT**
- **PERSONAL DIGITAL ASSISTANTS**
- **MODEMS**
- **BAR-CODE SCANNERS**
- **BACKUP POWER SUPPLIES**

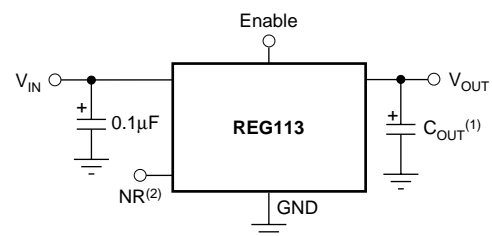
DESCRIPTION

The REG113 is a family of low-noise, low-dropout linear regulators with low ground pin current. Its new DMOS topology provides significant improvement over previous designs, including low-dropout voltage (only 250mV typ at full load), and better transient performance. In addition, no output capacitor is required for stability, unlike conventional low-dropout regulators that are difficult to compensate and require expensive low ESR capacitors greater than 1µF.

Typical ground pin current is only 850µA (at $I_{OUT} = 400mA$) and drops to 10nA when not enabled. Unlike regulators with PNP pass devices, quiescent current remains relatively constant over load variations and under dropout conditions.

The REG113 has very low output noise (typically 28µVrms for $V_{OUT} = 3.3V$ with $C_{NR} = 0.01\mu F$), making it ideal for use in portable communications equipment. Accuracy is maintained over temperature, line, and load variations. Key parameters are tested over the specified temperature range (−40°C to +85°C).

The REG113 is well protected—internal circuitry provides a current limit which protects the load from damage, furthermore, thermal protection circuitry keeps the chip from being damaged by excessive temperature. The REG113 is available in SOT23-5 and MSOP-8 packages.



NOTES: (1) Optional. (2) NR = Noise Reduction.



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ABSOLUTE MAXIMUM RATINGS⁽¹⁾

| | |
|---|-------------------|
| Supply Input Voltage, V_{IN} | -0.3V to 12V |
| Enable Input Voltage, V_{EN} | -0.3V to V_{IN} |
| NR Pin Voltage, V_{NR} | -0.3V to 6.0V |
| Output Short-Circuit Duration | Indefinite |
| Operating Temperature Range (T_J) | -55°C to +125°C |
| Storage Temperature Range (T_A) | -65°C to +150°C |
| Lead Temperature (soldering, 3s) | +240°C |

NOTE: (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability.



ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE/ORDERING INFORMATION⁽¹⁾

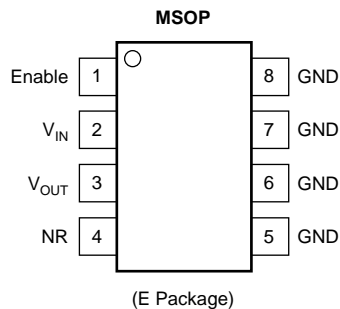
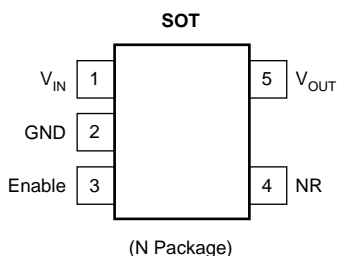
| PRODUCT | V_{OUT} ⁽²⁾ |
|-------------------|---|
| REG113xx-yyyy/zzz | <p>XX is package designator.</p> <p>YYYY is typical output voltage (5 = 5.0V, 2.85 = 2.85V, A = Adjustable).</p> <p>ZZZ is package quantity.</p> |

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

(2) Output voltages from 2.5V to 5.1V in 50mV increments are available; minimum order quantities apply. Contact factory for details and availability.

PIN CONFIGURATIONS

Top View



NOTE: Leads 5 through 8 are fused to the lead frame and can be used for improved thermal dissipation.

ELECTRICAL CHARACTERISTICS

Boldface limits apply over the specified temperature range, $T_J = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$.

At $T_J = +25^{\circ}\text{C}$, $V_{IN} = V_{OUT} + 1\text{V}$, $V_{ENABLE} = 1.8\text{V}$, $I_{OUT} = 5\text{mA}$, $C_{NR} = 0.01\mu\text{F}$, and $C_{OUT} = 0.1\mu\text{F}^{(1)}$, unless otherwise noted.

| PARAMETER | CONDITION | REG113NA REG113EA | | | UNITS |
|--|---------------|--|------------------------------------|-----------------------------|-------------------------|
| | | MIN | TYP | MAX | |
| OUTPUT VOLTAGE | | | | | |
| Output Voltage Range | V_{OUT} | | 2.5 | | V |
| REG113-2.5 | | | 2.85 | | V |
| REG113-2.85 | | | 3.0 | | V |
| REG113-3 | | | 3.3 | | V |
| REG113-3.3 | | | 5.0 | | V |
| REG113-5 | | | ± 0.5 | ± 1.5 | % |
| Accuracy | | | | ± 2.3 | % |
| Over Temperature vs Temperature | dV_{OUT}/dT | | 50 | ± 2.3 | ppm/ $^{\circ}\text{C}$ |
| vs Line and Load | | $I_{OUT} = 5\text{mA to } 400\text{mA}$, $V_{IN} = (V_{OUT} + 0.4\text{V})$ to 10V | ± 1 | ± 2.3 | % |
| Over Temperature | | $I_{OUT} = 5\text{mA to } 400\text{mA}$, $V_{IN} = (V_{OUT} + 0.6\text{V})$ to 10V | | ± 3.0 | % |
| DC DROPOUT VOLTAGE⁽²⁾ | V_{DROD} | | 4 | 10 | mV |
| For all models | | $I_{OUT} = 5\text{mA}$ | 250 | 325 | mV |
| Over Temperature | | $I_{OUT} = 400\text{mA}$ | | 410 | mV |
| | | $I_{OUT} = 400\text{mA}$ | | | mV |
| VOLTAGE NOISE | | | | | |
| $f = 10\text{Hz to } 100\text{kHz}$ | V_n | | | | |
| Without C_{NR} | | $C_{NR} = 0$, $C_{OUT} = 0$ | $23\mu\text{Vrms/V} \cdot V_{OUT}$ | | μVrms |
| With C_{NR} | | $C_{NR} = 0.01\mu\text{F}$, $C_{OUT} = 10\mu\text{F}$ | $7\mu\text{Vrms/V} \cdot V_{OUT}$ | | μVrms |
| OUTPUT CURRENT | | | | | |
| Current Limit ⁽³⁾ | I_{CL} | 425 | 500 | 575 | mA |
| Over Temperature | | | | 600 | mA |
| Short-Circuit Current Limit | I_{SC} | | 200 | | mA |
| RIPPLE REJECTION | | | 65 | | dB |
| $f = 120\text{Hz}$ | | | | | |
| ENABLE CONTROL | | | | | |
| V_{ENABLE} HIGH (output enabled) | V_{ENABLE} | 1.8 | | V_{IN} | V |
| V_{ENABLE} LOW (output disabled) | | -0.2 | | 0.5 | V |
| I_{ENABLE} HIGH (output enabled) | I_{ENABLE} | | 1 | 100 | nA |
| I_{ENABLE} LOW (output disabled) | | | 2 | 100 | nA |
| Output Disable Time | | | 50 | | μs |
| Output Enable Softstart Time | | | 1.5 | | ms |
| | | | | | |
| THERMAL SHUTDOWN | | | | | |
| Junction Temperature | | | 160 | | $^{\circ}\text{C}$ |
| Shutdown | | | 140 | | $^{\circ}\text{C}$ |
| Reset from Shutdown | | | | | |
| GROUND PIN CURRENT | | | | | |
| Ground Pin Current | I_{GND} | | 400 | 500 | μA |
| | | $I_{OUT} = 5\text{mA}$ | 850 | 1000 | μA |
| | | $I_{OUT} = 400\text{mA}$ | 0.01 | 0.2 | μA |
| Enable Pin LOW | | $V_{ENABLE} \leq 0.5\text{V}$ | | | |
| INPUT VOLTAGE | | | | | |
| Operating Input Voltage Range ⁽⁵⁾ | V_{IN} | 1.8 | | 10 | V |
| Specified Input Voltage Range | | $V_{IN} > 1.8\text{V}$ | $V_{OUT} + 0.4$ | 10 | V |
| Over Temperature | | $V_{IN} > 1.8\text{V}$ | $V_{OUT} + 0.6$ | 10 | V |
| TEMPERATURE RANGE | | | | | |
| Specified Range | T_J | -40 | | +85 | $^{\circ}\text{C}$ |
| Operating Range | T_J | -55 | | +125 | $^{\circ}\text{C}$ |
| Storage Range | T_A | -65 | | +150 | $^{\circ}\text{C}$ |
| Thermal Resistance | | | | | |
| SOT23-5 Surface-Mount | θ_{JA} | Junction-to-Ambient | 200 | | $^{\circ}\text{C/W}$ |
| MSOP-8 Surface-Mount | θ_{JC} | Junction-to-Case | 35 ⁽⁶⁾ | | $^{\circ}\text{C/W}$ |
| | θ_{JA} | Junction-to-Ambient | 160 ⁽⁶⁾ | | $^{\circ}\text{C/W}$ |

NOTES: (1) The REG113 does not require a minimum output capacitor for stability. However, transient response can be improved with proper capacitor selection.

(2) Dropout voltage is defined as the input voltage minus the output voltage that produces a 2% change in the output voltage from the value at $V_{IN} = V_{OUT} + 1\text{V}$ at fixed load.

(3) Current limit is the output current that produces a 10% change in output voltage from $V_{IN} = V_{OUT} + 1\text{V}$ and $I_{OUT} = 5\text{mA}$.

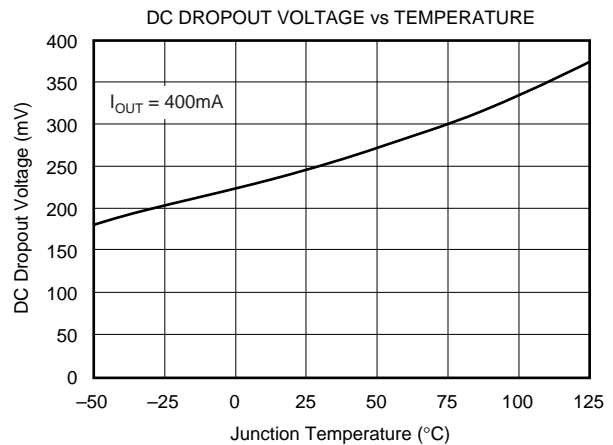
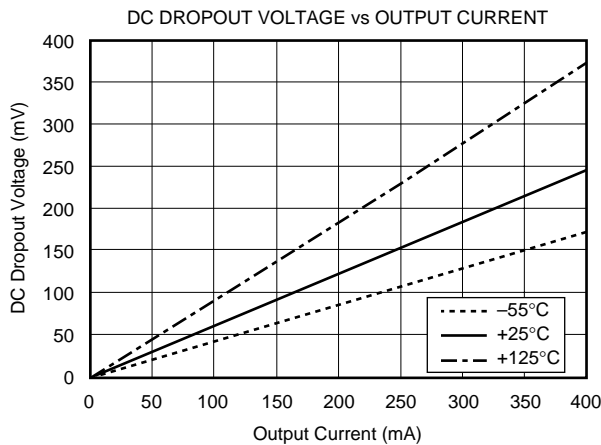
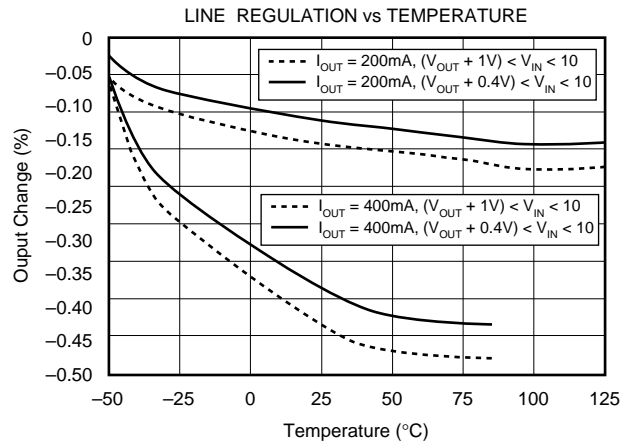
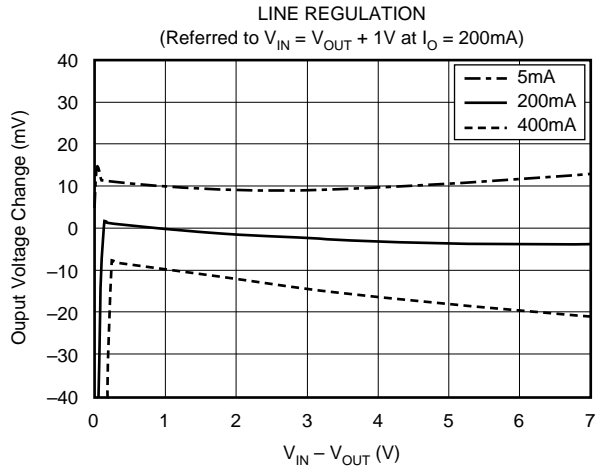
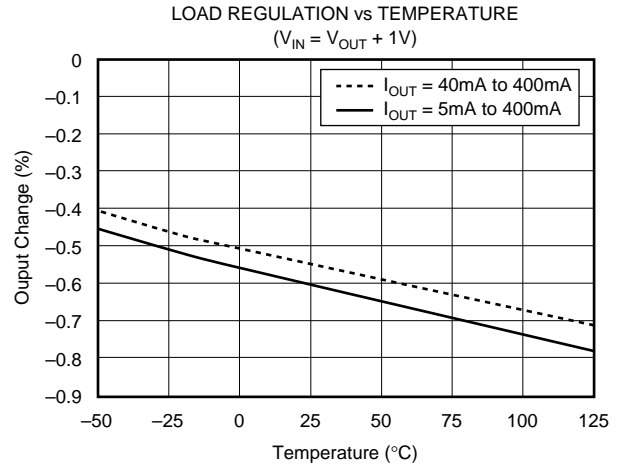
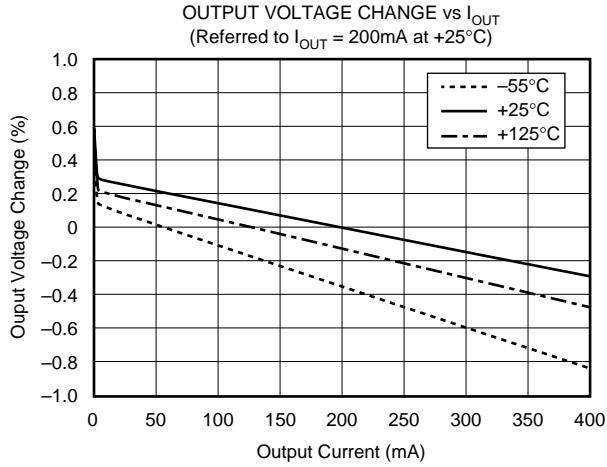
(4) For $V_{ENABLE} > 6.5\text{V}$, see typical characteristic I_{ENABLE} vs V_{ENABLE} .

(5) The REG113 no longer regulates when $V_{IN} < V_{OUT} + V_{DROD(MAX)}$. In dropout, the impedance from V_{IN} to V_{OUT} is typically less than 1Ω at $T_J = +25^{\circ}\text{C}$.

(6) See Figure 7.

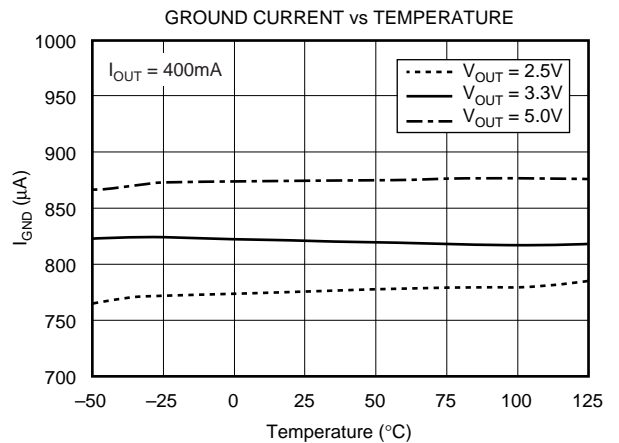
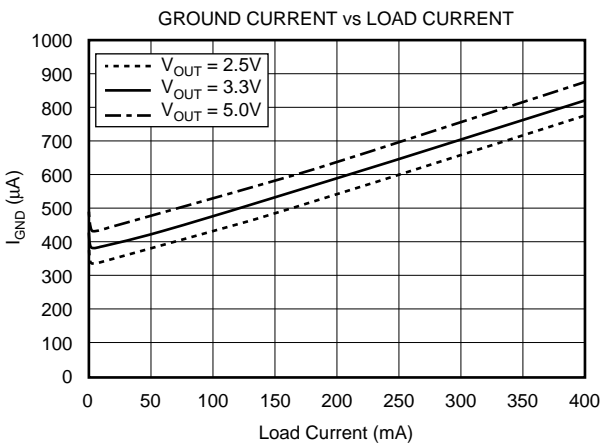
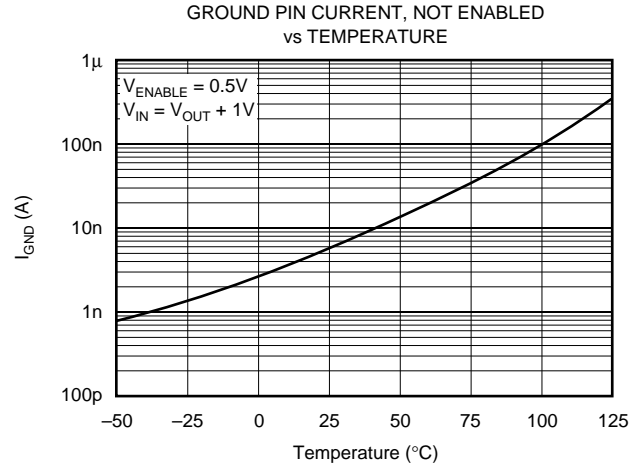
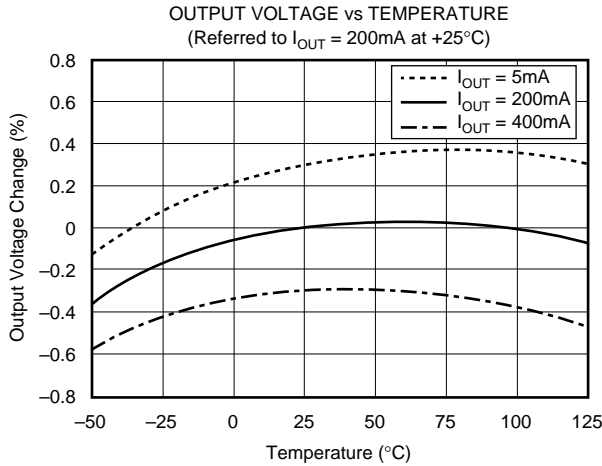
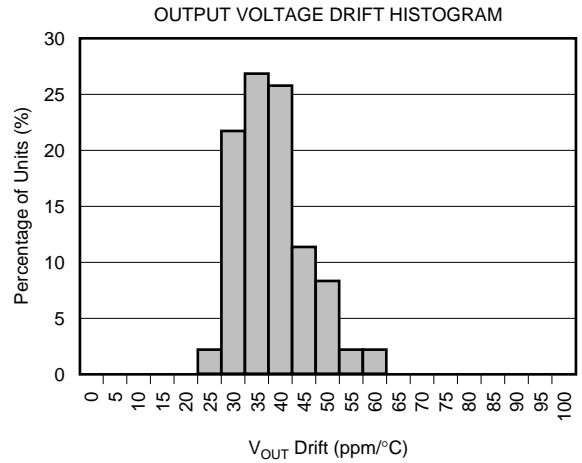
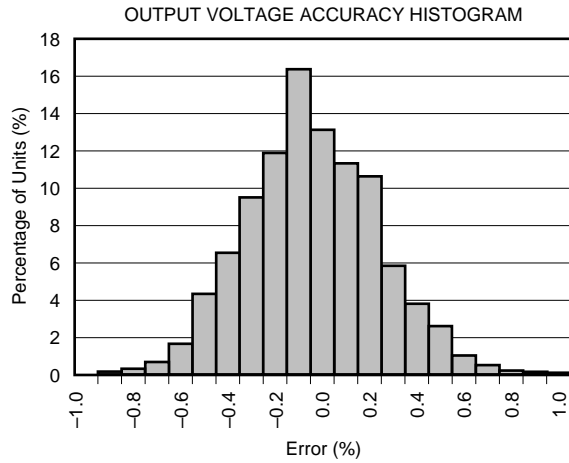
TYPICAL CHARACTERISTICS

For all models, at $T_J = +25^\circ\text{C}$ and $V_{\text{ENABLE}} = 1.8\text{V}$, unless otherwise noted.



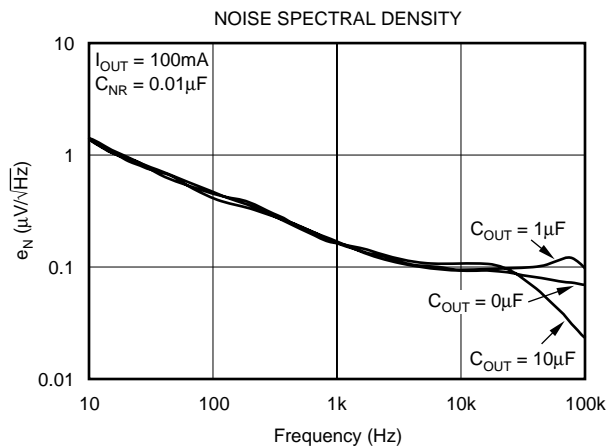
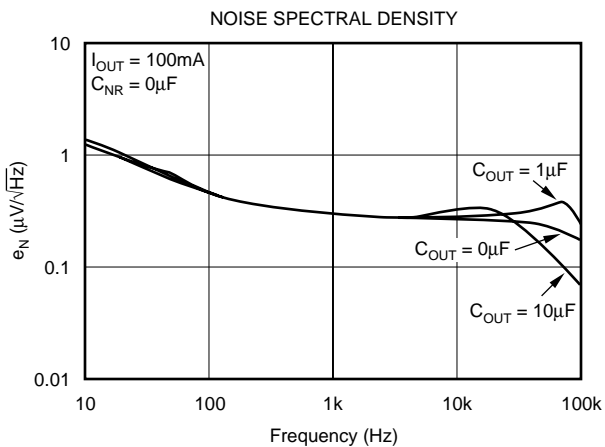
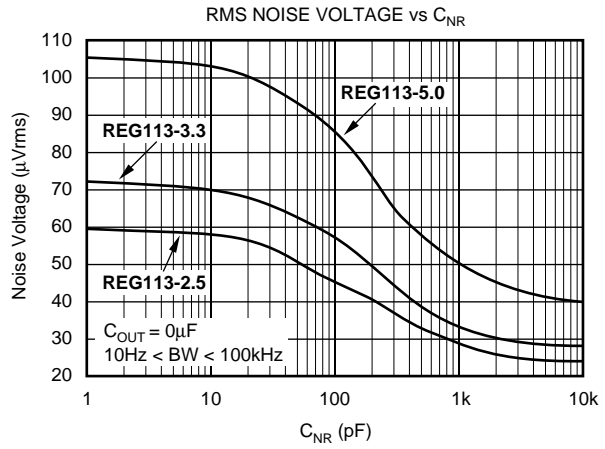
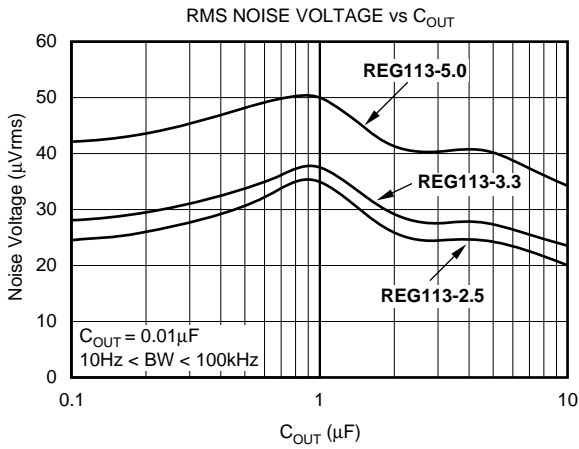
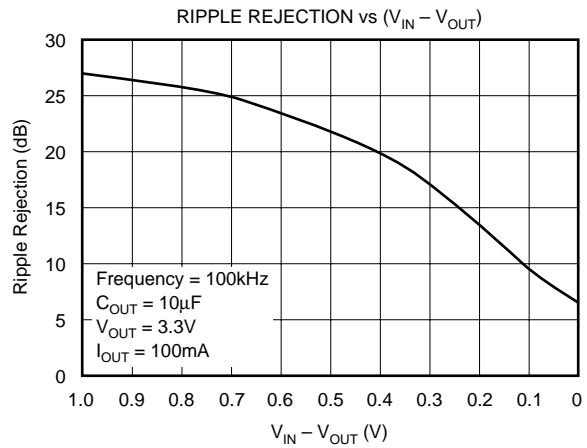
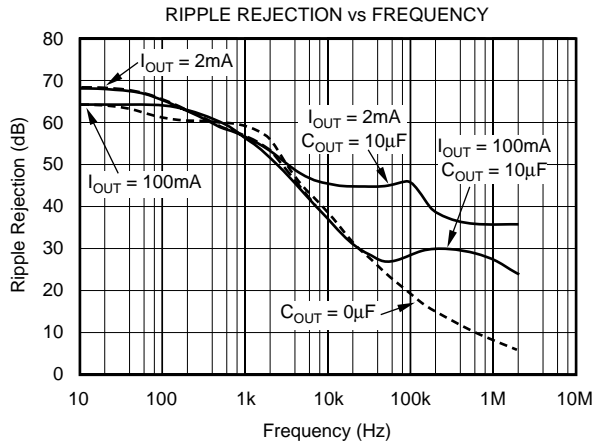
TYPICAL CHARACTERISTICS (Cont.)

For all models, at $T_J = +25^\circ\text{C}$ and $V_{\text{ENABLE}} = 1.8\text{V}$, unless otherwise noted.



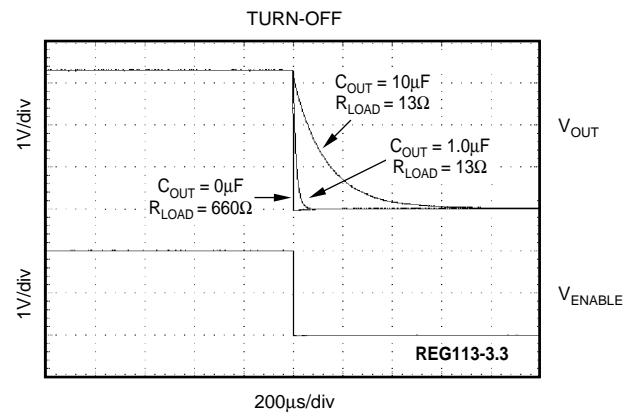
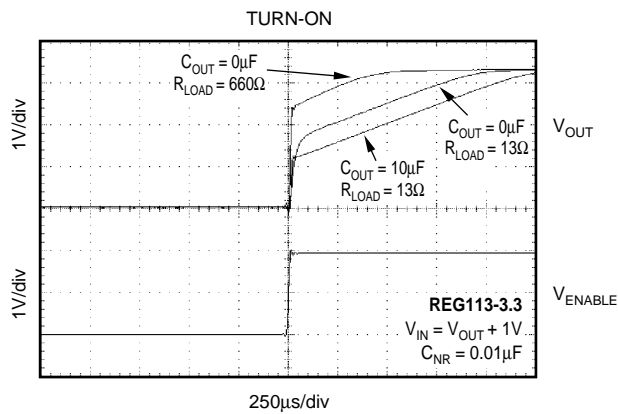
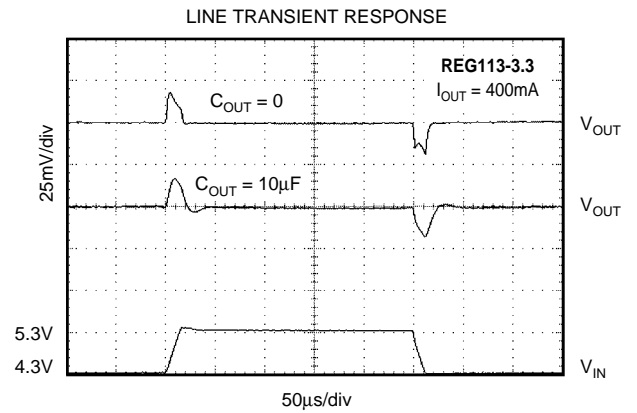
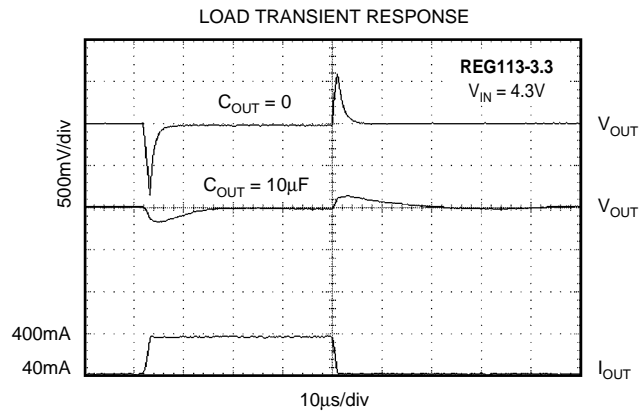
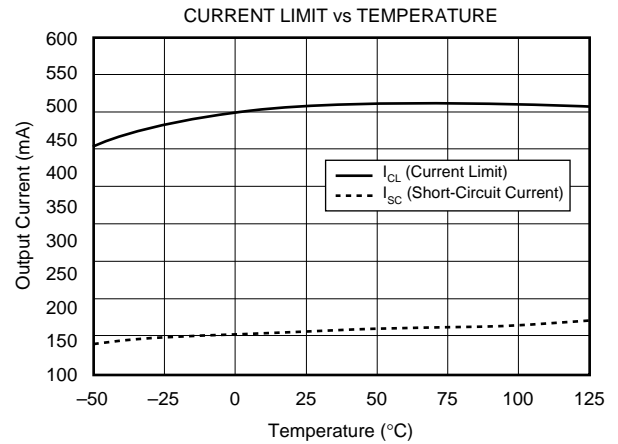
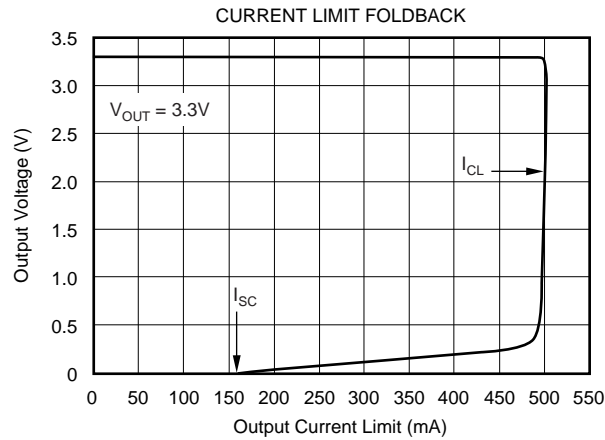
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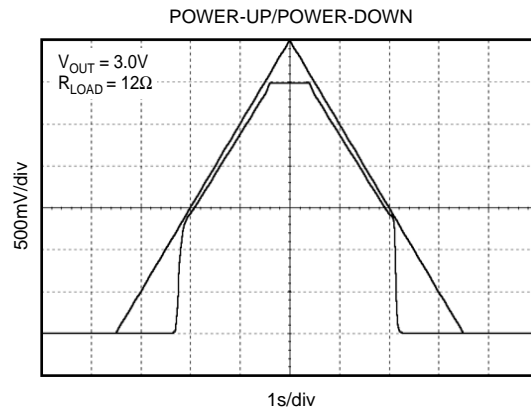
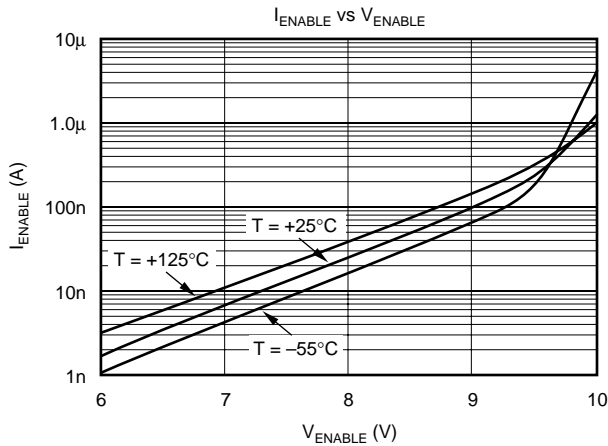
TYPICAL CHARACTERISTICS (Cont.)

For all models, at $T_J = +25^\circ\text{C}$ and $V_{\text{ENABLE}} = 1.8\text{V}$, unless otherwise noted.



TYPICAL CHARACTERISTICS (Cont.)

For all models, at $T_J = +25^\circ\text{C}$ and $V_{\text{ENABLE}} = 1.8\text{V}$, unless otherwise noted.



BASIC OPERATION

The REG113 series of LDO (low dropout) linear regulators offers a wide selection of fixed output voltage versions and an adjustable output version. The REG113 belongs to a family of new generation LDO regulators that use a DMOS pass transistor to achieve ultra low-dropout performance and freedom from output capacitor constraints. Ground pin current remains under 1mA over all line, load, and temperature conditions. All versions have thermal and over-current protection, including foldback current limit.

The REG113 does not require an output capacitor for regulator stability and is stable over most output currents and with almost any value and type of output capacitor up to 10 μF or more. For applications where the regulator output current drops below several milliamps, stability can be enhanced by adding a 1k Ω to 2k Ω load resistor, using capacitance values smaller than 10 μF , or keeping the effective series resistance greater than 0.05 Ω including the capacitor ESR and parasitic resistance in printed circuit board traces, solder joints, and sockets.

Although an input capacitor is not required, it is a good standard analog design practice to connect a 0.1 μF low ESR capacitor across the input supply voltage; this is recommended to counteract reactive input sources and improve ripple rejection by reducing input voltage ripple. Figure 1 shows the basic circuit connections for the fixed voltage models.

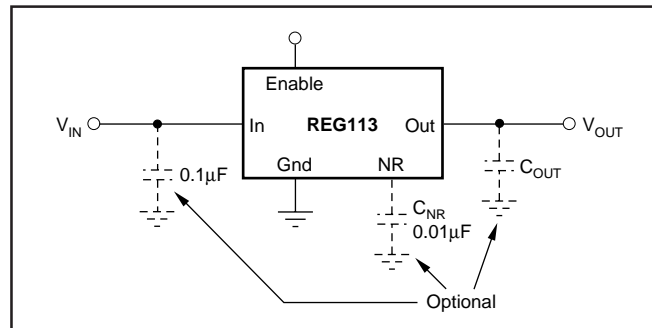


FIGURE 1. Fixed Voltage Nominal Circuit for the REG113.

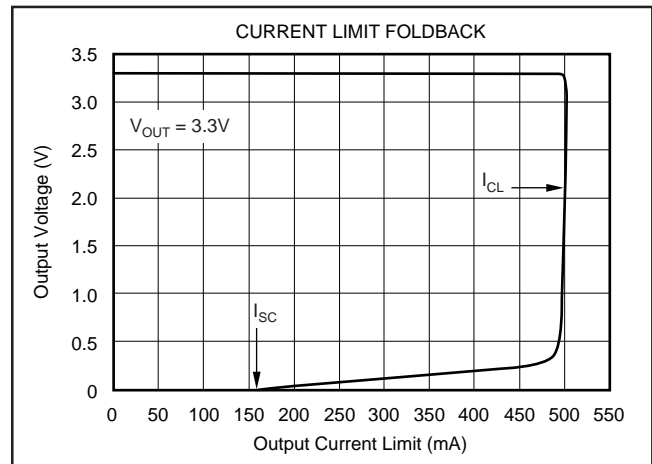


FIGURE 2. Foldback Current Limit of the REG113-3.3 at 25 $^\circ\text{C}$.

INTERNAL CURRENT LIMIT

The REG113 internal current limit has a typical value of 500mA. A foldback feature limits the short-circuit current to a typical short-circuit value of 200mA. A curve of V_{OUT} versus I_{OUT} is given in Figure 2, and in the Typical Characteristics section.

ENABLE

The Enable pin is active high and compatible with standard TTL-CMOS levels. Inputs below 0.5V (max) turn the regulator off and all circuitry is disabled. Under this condition, ground pin current drops to approximately 10nA. When not used, the Enable pin can be connected to V_{IN} .

OUTPUT NOISE

A precision bandgap reference is used to generate the internal reference voltage, V_{REF} . This reference is the dominant noise source within the REG113 and generates approximately $29\mu\text{V}_{\text{rms}}$ in the 10Hz to 100kHz bandwidth at the reference output. The regulator control loop gains up the reference noise, so that the noise voltage of the regulator is approximately given by:

$$V_N = 29\mu\text{V}_{\text{rms}} \frac{R_1 + R_2}{R_2} = 29\mu\text{V}_{\text{rms}} \cdot \frac{V_{\text{OUT}}}{V_{\text{REF}}} \quad (1)$$

Since the value of V_{REF} is 1.26V, this relationship reduces to:

$$V_N = 23 \frac{\mu\text{V}_{\text{rms}}}{\text{V}} \cdot V_{\text{OUT}} \quad (2)$$

Connecting a capacitor, C_{NR} , from the Noise Reduction (NR) pin to ground (as shown in Figure 3) forms a low-pass filter for the voltage reference. For $C_{NR} = 10\text{nF}$, the total noise in the 10Hz to 100kHz bandwidth is reduced by approximately a factor of 2.8 for $V_{\text{OUT}} = 3.3\text{V}$. This noise reduction effect is shown in Figure 4, and as *RMS Noise Voltage vs C_{NR}* in the Typical Characteristics section.

Noise can be further reduced by carefully choosing an output capacitor, C_{OUT} . Best overall noise performance is achieved with very low ($< 0.22\mu\text{F}$) or very high ($> 2.2\mu\text{F}$) values of C_{OUT} (see the *RMS Noise Voltage vs C_{OUT}* typical characteristic).

The REG113 uses an internal charge pump to develop an internal supply voltage sufficient to drive the gate of the DMOS pass element above V_{IN} . The charge-pump switching noise (nominal switching frequency = 2MHz) is not measurable at the output of the regulator over most values of I_{OUT} and C_{OUT} .

DROPOUT VOLTAGE

The REG113 uses an N-channel DMOS as the pass element. When $(V_{\text{IN}} - V_{\text{OUT}})$ is less than the dropout voltage (V_{DROPOUT}), the DMOS pass device behaves like a resistor; therefore, for low values of $(V_{\text{IN}} - V_{\text{OUT}})$, the regulator input-to-output resistance is the $R_{\text{ds(ON)}}$ of the DMOS pass element (typically $600\text{m}\Omega$). For static (DC) loads, the REG113 will

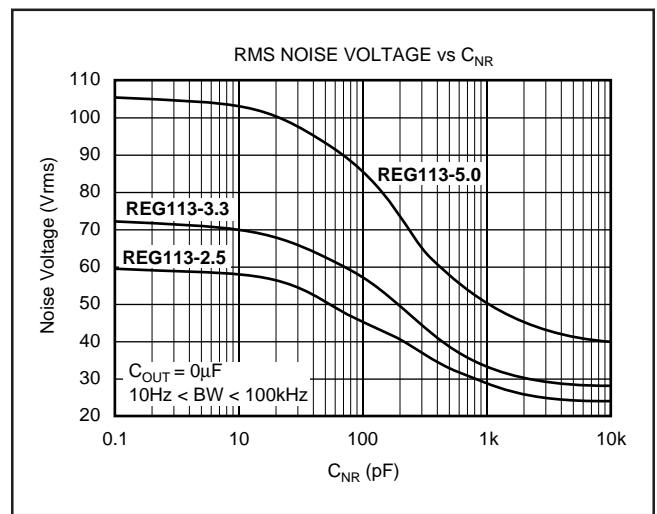


FIGURE 4. Output Noise versus Noise Reduction Capacitor.

typically maintain regulation down to a $(V_{\text{IN}} - V_{\text{OUT}})$ voltage drop of 250mV at full rated output current. In Figure 5, the bottom line (DC dropout) shows the minimum V_{IN} to V_{OUT} voltage drop required to prevent dropout under DC load conditions.

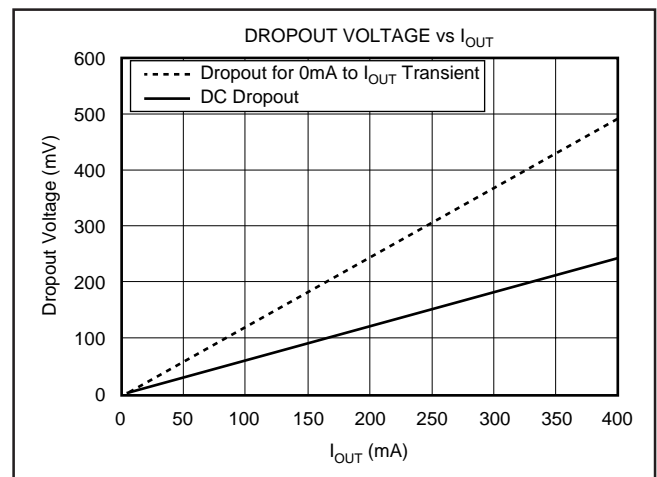


FIGURE 5. Transient and DC Dropout.

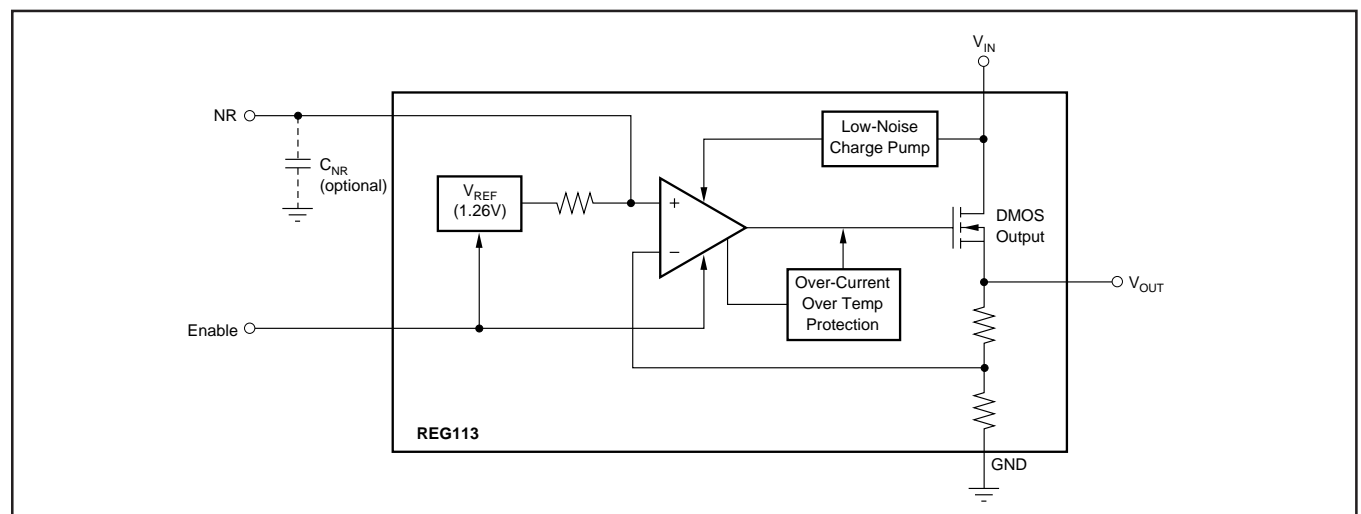


FIGURE 3. Block Diagram.

Power dissipation depends on input voltage, load conditions, and duty cycle and is equal to the product of the average output current times the voltage across the output element (V_{IN} to V_{OUT} voltage drop):

$$P_D = (V_{IN} - V_{OUT}) \cdot I_{OUT} \quad (3)$$

Power dissipation can be minimized by using the lowest possible input voltage necessary to assure the required output voltage.

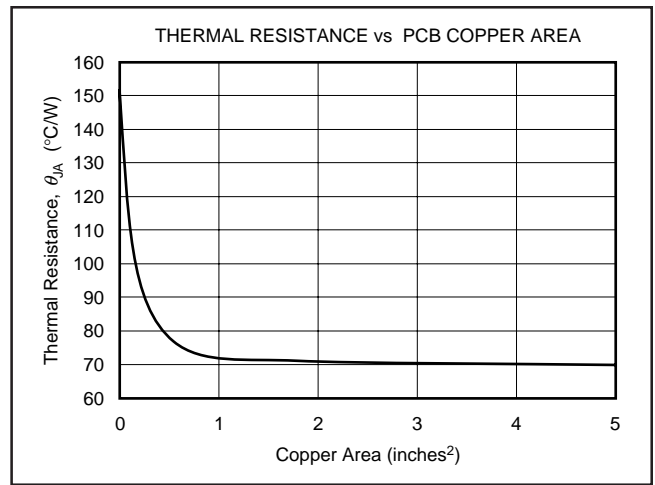


FIGURE 7. Thermal Resistance versus PCB Area for the MSOP-8.

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|--------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| REG113EA-2.5/250 | ACTIVE | VSSOP | DGK | 8 | 250 | RoHS & Green | NIPDAUAG | Level-2-260C-1 YEAR | -40 to 85 | R13G | Samples |
| REG113EA-2.5/250G4 | ACTIVE | VSSOP | DGK | 8 | 250 | RoHS & Green | NIPDAUAG | Level-2-260C-1 YEAR | -40 to 85 | R13G | Samples |
| REG113EA-2.5/2K5 | ACTIVE | VSSOP | DGK | 8 | 2500 | RoHS & Green | NIPDAUAG | Level-2-260C-1 YEAR | -40 to 85 | R13G | Samples |
| REG113EA-3.3/250 | ACTIVE | VSSOP | DGK | 8 | 250 | RoHS & Green | NIPDAUAG | Level-2-260C-1 YEAR | -40 to 85 | R13C | Samples |
| REG113EA-3.3/2K5 | ACTIVE | VSSOP | DGK | 8 | 2500 | RoHS & Green | NIPDAUAG | Level-2-260C-1 YEAR | -40 to 85 | R13C | Samples |
| REG113EA-3/2K5 | ACTIVE | VSSOP | DGK | 8 | 2500 | RoHS & Green | NIPDAUAG | Level-2-260C-1 YEAR | -40 to 85 | R13D | Samples |
| REG113EA-5/250 | ACTIVE | VSSOP | DGK | 8 | 250 | RoHS & Green | NIPDAUAG | Level-2-260C-1 YEAR | -40 to 85 | R13B | Samples |
| REG113EA-5/2K5 | ACTIVE | VSSOP | DGK | 8 | 2500 | RoHS & Green | NIPDAUAG | Level-2-260C-1 YEAR | -40 to 85 | R13B | Samples |
| REG113EA-5/2K5G4 | ACTIVE | VSSOP | DGK | 8 | 2500 | RoHS & Green | NIPDAUAG | Level-2-260C-1 YEAR | -40 to 85 | R13B | Samples |
| REG113NA-2.5/250 | ACTIVE | SOT-23 | DBV | 5 | 250 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | R13G | Samples |
| REG113NA-2.5/3K | ACTIVE | SOT-23 | DBV | 5 | 3000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | R13G | Samples |
| REG113NA-2.85/250 | ACTIVE | SOT-23 | DBV | 5 | 250 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | R13N | Samples |
| REG113NA-2.85/3K | ACTIVE | SOT-23 | DBV | 5 | 3000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | R13N | Samples |
| REG113NA-3.3/250 | ACTIVE | SOT-23 | DBV | 5 | 250 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | R13C | Samples |
| REG113NA-3.3/250G4 | ACTIVE | SOT-23 | DBV | 5 | 250 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | R13C | Samples |
| REG113NA-3.3/3K | ACTIVE | SOT-23 | DBV | 5 | 3000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | R13C | Samples |
| REG113NA-3/250 | ACTIVE | SOT-23 | DBV | 5 | 250 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | R13D | Samples |
| REG113NA-3/3K | ACTIVE | SOT-23 | DBV | 5 | 3000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | R13D | Samples |
| REG113NA-3/3KG4 | ACTIVE | SOT-23 | DBV | 5 | 3000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | R13D | Samples |
| REG113NA-5/250 | ACTIVE | SOT-23 | DBV | 5 | 250 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | R13B | Samples |

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| REG113NA-5/250G4 | ACTIVE | SOT-23 | DBV | 5 | 250 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | R13B | Samples |
| REG113NA-5/3K | ACTIVE | SOT-23 | DBV | 5 | 3000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | R13B | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) **MSL, Peak Temp.** - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) **Lead finish/Ball material** - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION

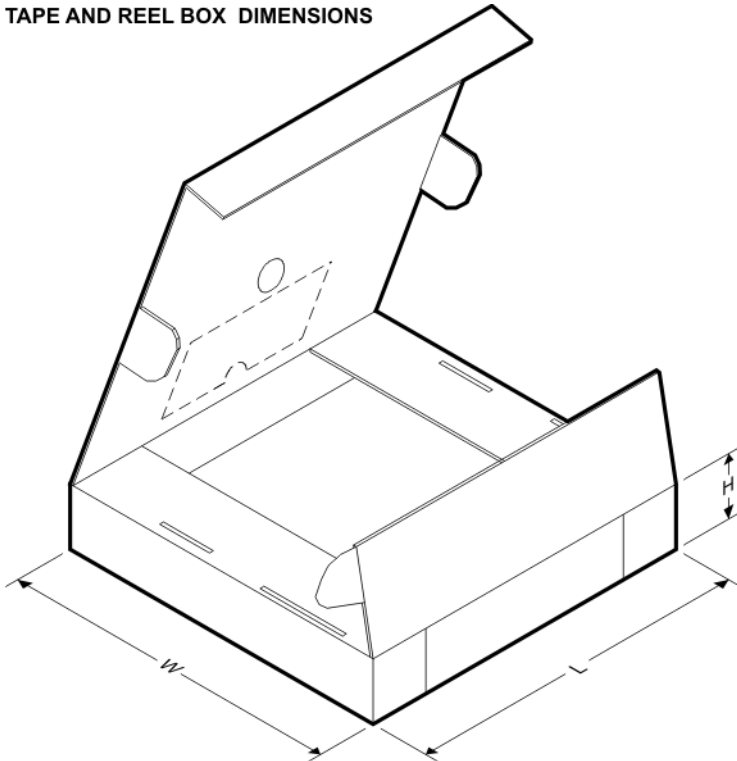


QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| REG113EA-2.5/250 | VSSOP | DGK | 8 | 250 | 180.0 | 12.4 | 5.3 | 3.4 | 1.4 | 8.0 | 12.0 | Q1 |
| REG113EA-2.5/2K5 | VSSOP | DGK | 8 | 2500 | 330.0 | 12.4 | 5.3 | 3.4 | 1.4 | 8.0 | 12.0 | Q1 |
| REG113EA-3.3/250 | VSSOP | DGK | 8 | 250 | 180.0 | 12.4 | 5.3 | 3.4 | 1.4 | 8.0 | 12.0 | Q1 |
| REG113EA-3.3/2K5 | VSSOP | DGK | 8 | 2500 | 330.0 | 12.4 | 5.3 | 3.4 | 1.4 | 8.0 | 12.0 | Q1 |
| REG113EA-3/2K5 | VSSOP | DGK | 8 | 2500 | 330.0 | 12.4 | 5.3 | 3.4 | 1.4 | 8.0 | 12.0 | Q1 |
| REG113EA-5/250 | VSSOP | DGK | 8 | 250 | 180.0 | 12.4 | 5.3 | 3.4 | 1.4 | 8.0 | 12.0 | Q1 |
| REG113EA-5/2K5 | VSSOP | DGK | 8 | 2500 | 330.0 | 12.4 | 5.3 | 3.4 | 1.4 | 8.0 | 12.0 | Q1 |
| REG113NA-2.5/250 | SOT-23 | DBV | 5 | 250 | 179.0 | 8.4 | 3.2 | 3.2 | 1.4 | 4.0 | 8.0 | Q3 |
| REG113NA-2.5/3K | SOT-23 | DBV | 5 | 3000 | 179.0 | 8.4 | 3.2 | 3.2 | 1.4 | 4.0 | 8.0 | Q3 |
| REG113NA-2.85/250 | SOT-23 | DBV | 5 | 250 | 179.0 | 8.4 | 3.2 | 3.2 | 1.4 | 4.0 | 8.0 | Q3 |
| REG113NA-2.85/3K | SOT-23 | DBV | 5 | 3000 | 179.0 | 8.4 | 3.2 | 3.2 | 1.4 | 4.0 | 8.0 | Q3 |
| REG113NA-3.3/250 | SOT-23 | DBV | 5 | 250 | 179.0 | 8.4 | 3.2 | 3.2 | 1.4 | 4.0 | 8.0 | Q3 |
| REG113NA-3.3/3K | SOT-23 | DBV | 5 | 3000 | 179.0 | 8.4 | 3.2 | 3.2 | 1.4 | 4.0 | 8.0 | Q3 |
| REG113NA-3/250 | SOT-23 | DBV | 5 | 250 | 179.0 | 8.4 | 3.2 | 3.2 | 1.4 | 4.0 | 8.0 | Q3 |
| REG113NA-3/3K | SOT-23 | DBV | 5 | 3000 | 179.0 | 8.4 | 3.2 | 3.2 | 1.4 | 4.0 | 8.0 | Q3 |
| REG113NA-5/250 | SOT-23 | DBV | 5 | 250 | 179.0 | 8.4 | 3.2 | 3.2 | 1.4 | 4.0 | 8.0 | Q3 |
| REG113NA-5/3K | SOT-23 | DBV | 5 | 3000 | 179.0 | 8.4 | 3.2 | 3.2 | 1.4 | 4.0 | 8.0 | Q3 |

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| REG113EA-2.5/250 | VSSOP | DGK | 8 | 250 | 210.0 | 185.0 | 35.0 |
| REG113EA-2.5/2K5 | VSSOP | DGK | 8 | 2500 | 853.0 | 449.0 | 35.0 |
| REG113EA-3.3/250 | VSSOP | DGK | 8 | 250 | 210.0 | 185.0 | 35.0 |
| REG113EA-3.3/2K5 | VSSOP | DGK | 8 | 2500 | 853.0 | 449.0 | 35.0 |
| REG113EA-3/2K5 | VSSOP | DGK | 8 | 2500 | 853.0 | 449.0 | 35.0 |
| REG113EA-5/250 | VSSOP | DGK | 8 | 250 | 210.0 | 185.0 | 35.0 |
| REG113EA-5/2K5 | VSSOP | DGK | 8 | 2500 | 853.0 | 449.0 | 35.0 |
| REG113NA-2.5/250 | SOT-23 | DBV | 5 | 250 | 200.0 | 183.0 | 25.0 |
| REG113NA-2.5/3K | SOT-23 | DBV | 5 | 3000 | 200.0 | 183.0 | 25.0 |
| REG113NA-2.85/250 | SOT-23 | DBV | 5 | 250 | 200.0 | 183.0 | 25.0 |
| REG113NA-2.85/3K | SOT-23 | DBV | 5 | 3000 | 200.0 | 183.0 | 25.0 |
| REG113NA-3.3/250 | SOT-23 | DBV | 5 | 250 | 200.0 | 183.0 | 25.0 |
| REG113NA-3.3/3K | SOT-23 | DBV | 5 | 3000 | 200.0 | 183.0 | 25.0 |
| REG113NA-3/250 | SOT-23 | DBV | 5 | 250 | 200.0 | 183.0 | 25.0 |
| REG113NA-3/3K | SOT-23 | DBV | 5 | 3000 | 200.0 | 183.0 | 25.0 |
| REG113NA-5/250 | SOT-23 | DBV | 5 | 250 | 200.0 | 183.0 | 25.0 |
| REG113NA-5/3K | SOT-23 | DBV | 5 | 3000 | 200.0 | 183.0 | 25.0 |

EXAMPLE BOARD LAYOUT

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:15X



SOLDER MASK DETAILS

4214839/E 09/2019

NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:15X

4214839/E 09/2019

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

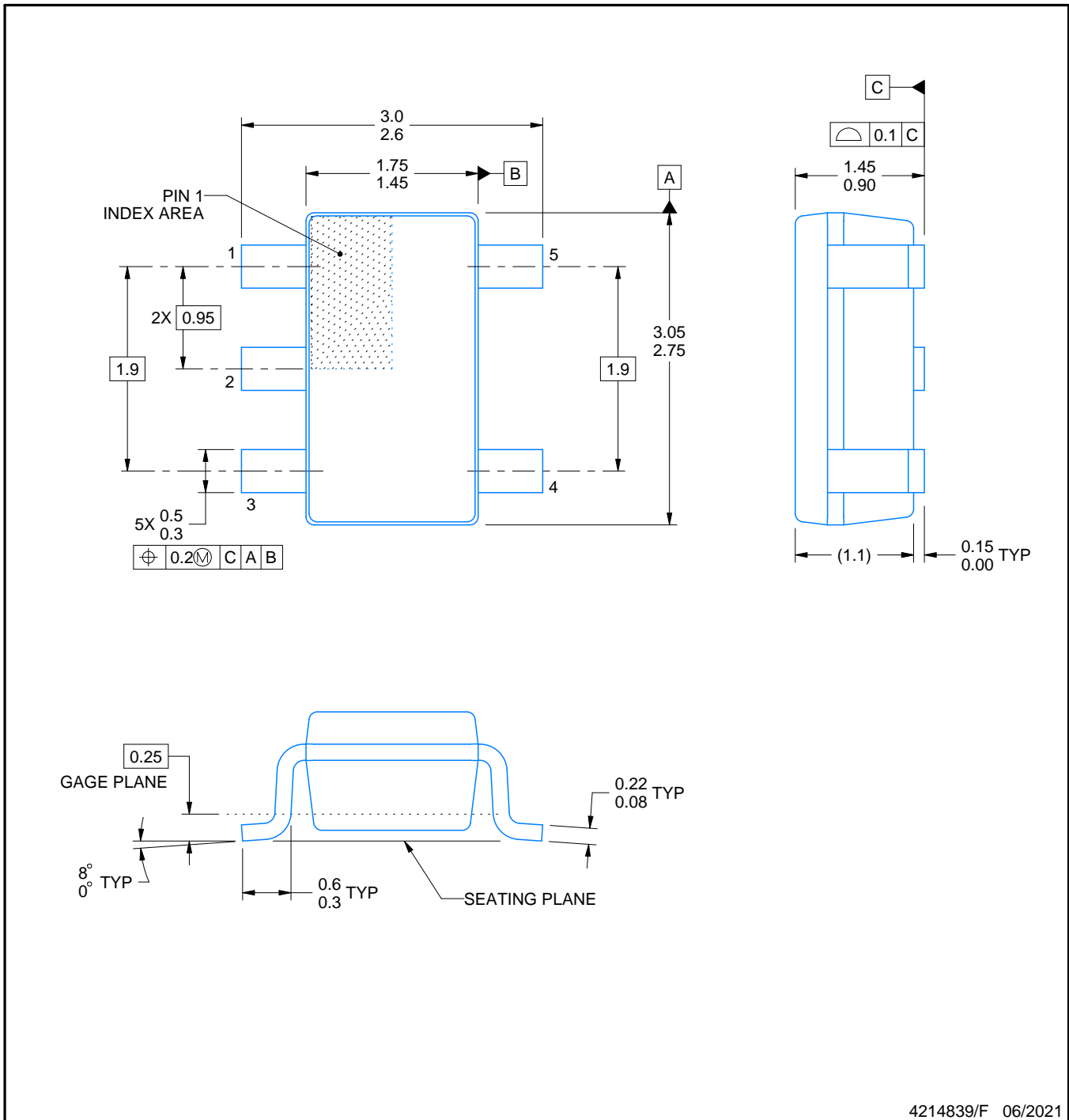
DBV0005A



PACKAGE OUTLINE

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



4214839/F 06/2021

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-178.
4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.

EXAMPLE BOARD LAYOUT

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:15X



SOLDER MASK DETAILS

4214839/F 06/2021

NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:15X

4214839/F 06/2021

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

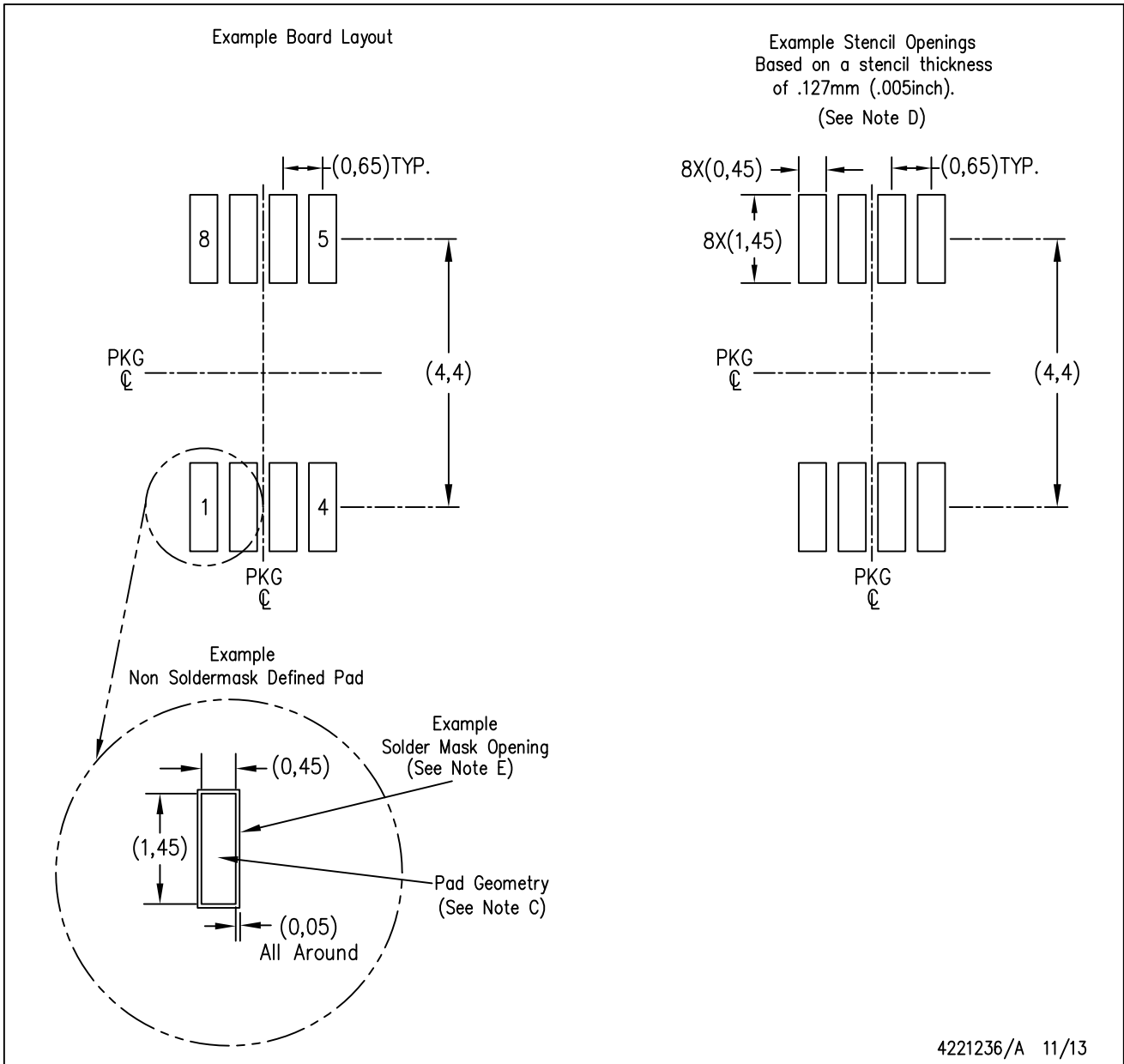
DGK (S-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



4073329/E 05/06

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
 - E. Falls within JEDEC MO-187 variation AA, except interlead flash.



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Publication IPC-7351 is recommended for alternate designs.
 - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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